



• General Description

The ZM025N03S combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$. This device is ideal for load switch and battery protection applications.

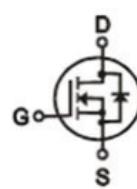
• Features

- Advance high cell density Trench technology
- Low $R_{DS(ON)}$ to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

• Application

- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

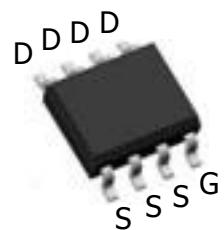
• Product Summary



$V_{DS}=30V$

$R_{DS(ON)}=2.5m\Omega$

$I_D=26A$



SOP-8

• Ordering Information:

Part NO.	ZM025N03S
Marking	ZM025N03
Packing Information	REEL TAPE
Basic ordering unit (pcs)	4000

• Absolute Maximum Ratings ($T_C = 25^\circ C$)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	$I_D@TC=25^\circ C$	26	A
	$I_D@TC=75^\circ C$	20	A
	$I_D@TC=100^\circ C$	16	A
Pulsed Drain Current ^①	I_{DM}	78	A
Total Power Dissipation	$P_D@TC=25^\circ C$	4.0	W
Total Power Dissipation	$P_D@TA=25^\circ C$	0.75	W
Operating Junction Temperature	T_J	-55 to 150	°C
Storage Temperature	T_{STG}	-55 to 150	°C
Single Pulse Avalanche Energy	E_{AS}	320	mJ


•Thermal resistance

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal resistance, junction - case	R _{thJC}	-	-	32	° C/W
Thermal resistance, junction - ambient	R _{thJA}	-	-	170	° C/W
Soldering temperature, wave soldering for 10s	T _{sold}	-	-	265	° C

•Electronic Characteristics

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	30			V
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} =V _{DS} , I _D =250uA	1.2		2.5	V
Drain-Source Leakage Current	I _{DSS}	V _{DS} =30V, V _{GS} =0V			1.0	uA
Gate- Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V			±100	nA
Static Drain-source On Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =15A		2.5	3.5	mΩ
		V _{GS} =4.5V, I _D =12A		3.5	5	mΩ
Forward Transconductance	g _{FS}	V _{DS} =25V, I _D =10A		30		s
Source-drain voltage	V _{SD}	I _S =15A			1.28	V

•Electronic Characteristics

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Input capacitance	C _{iss}	f = 1MHz, V _{DS} =25V	-	5200	-	pF
Output capacitance	C _{oss}		-	650	-	
Reverse transfer capacitance	C _{rss}		-	500	-	

•Gate Charge characteristics(T_A = 25°C)

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Gate Resistance	R _g	f = 1MHz		1.0		Ω
Total gate charge	Q _g	V _{DD} = 25V I _D = 8A V _{GS} = 10V	-	104	-	nC
Gate - Source charge	Q _{gs}		-	14	-	
Gate - Drain charge	Q _{gd}		-	31	-	
Turn-ON Delay time	t _{D(on)}	V _{GS} =10V, V _{DS} =15V R _G =3.3Ω,		12		ns
Turn-ON Rise time	t _r			7		ns



Turn-Off Delay time	$t_{D(\text{off})}$	$I_D = 20\text{A}$ $VDD = 20\text{ V}$, $dIS/dt=100\text{A}/\mu\text{s}$, $IS = 30\text{ A}$		53		ns
Turn-Off Fall time	t_f			14		ns
Reverse Recovery Time	t_{RR}			19.3		ns
Charge Time	t_a			10.9		ns
Discharge Time	t_b			8.4		ns
Reverse Recovery Charge	Q_{RR}			9.5		ns

Note: ① Pulse Test : Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$;

Fig.1 Power Dissipation

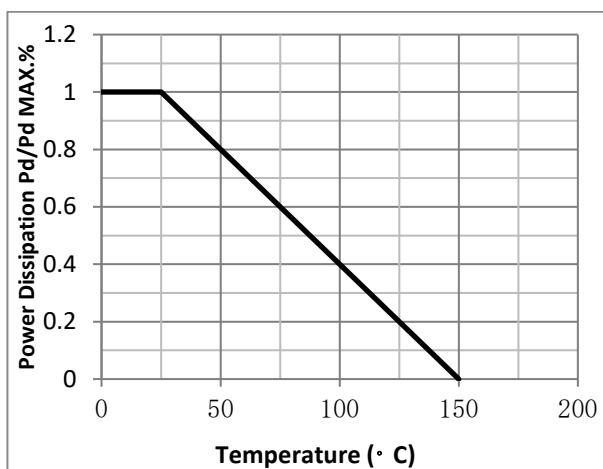


Fig.2 Typical output Characteristics

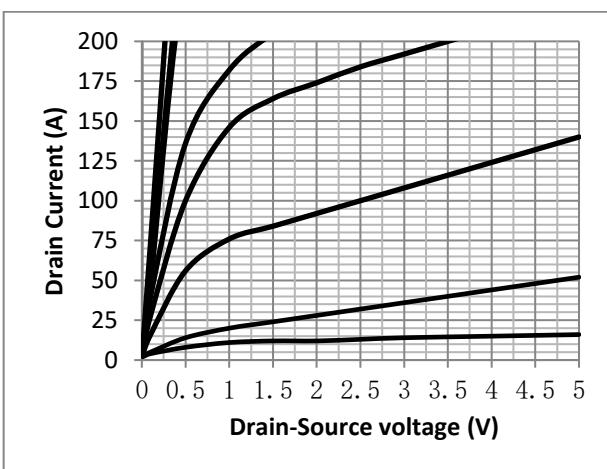


Fig.3 Threshold Voltage V.S Junction Temperature

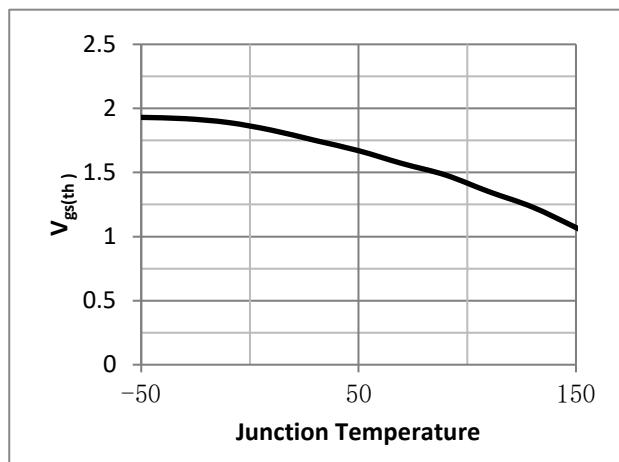


Fig.4 Resistance V.S Drain Current

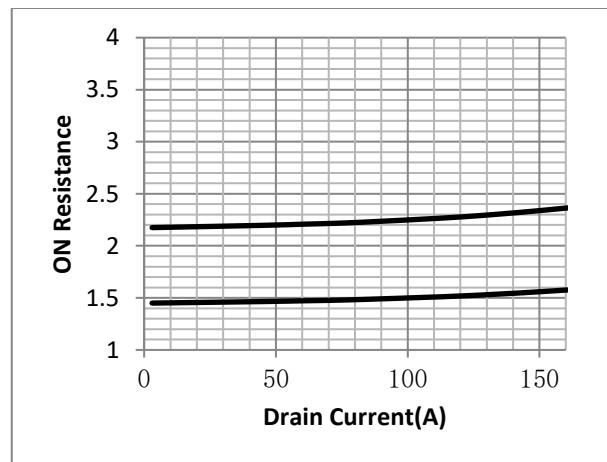




Fig.5 On-Resistance VS Gate Source Voltage

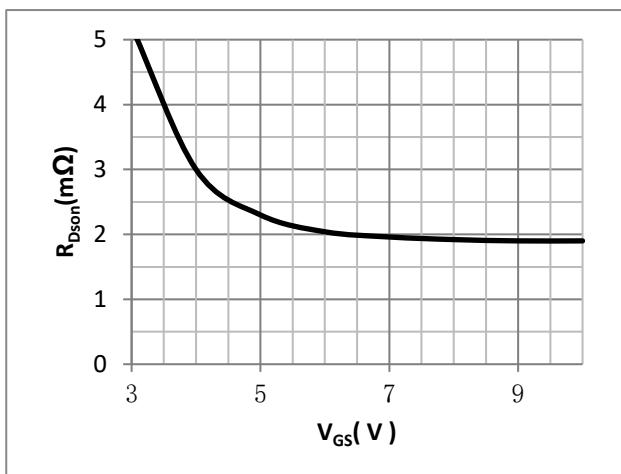


Fig.6 On-Resistance V.S Junction Temperature

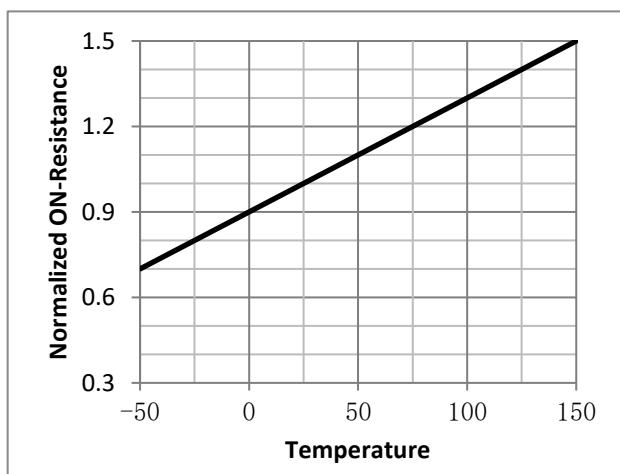


Fig.7 Safe Operating Area

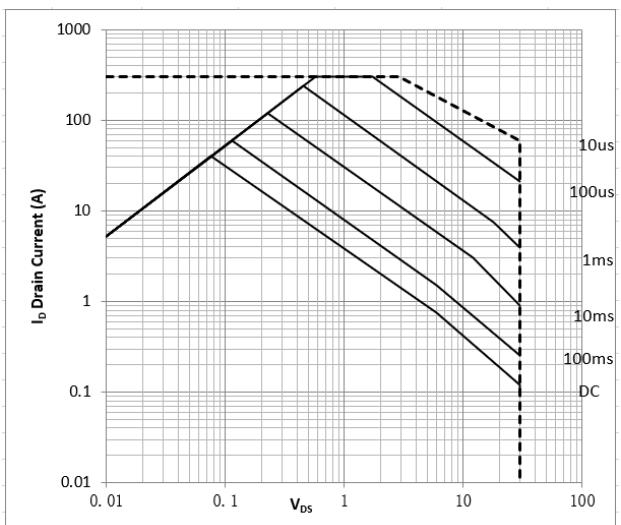


Fig.8 Drain Current V.S Junction Temperature

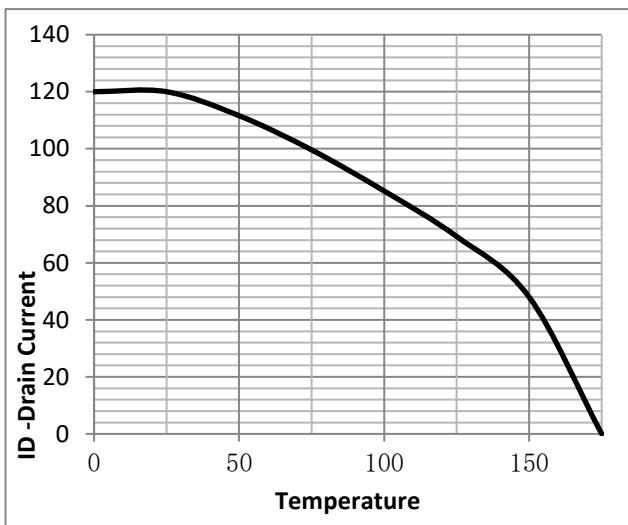


Fig.9 Diode Forward Voltage vs. Current

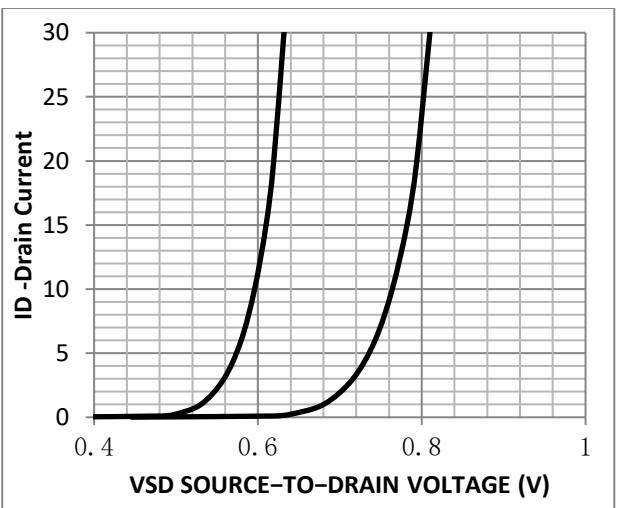


Fig.10 Capacitance Variation

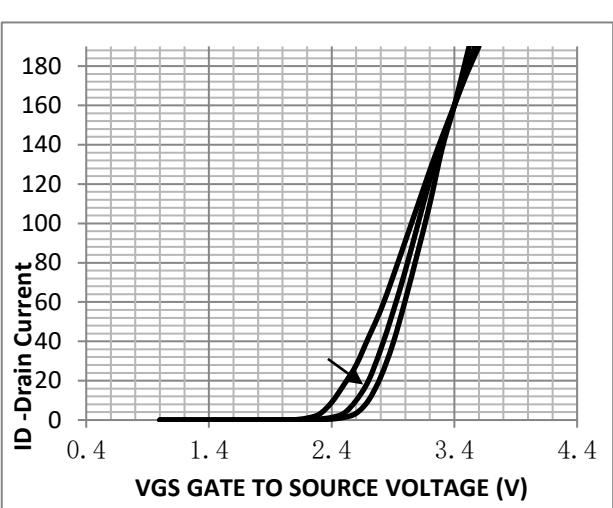




Figure 11. Gate-to-Source and Drain-to-Source Voltage vs. Total Charge

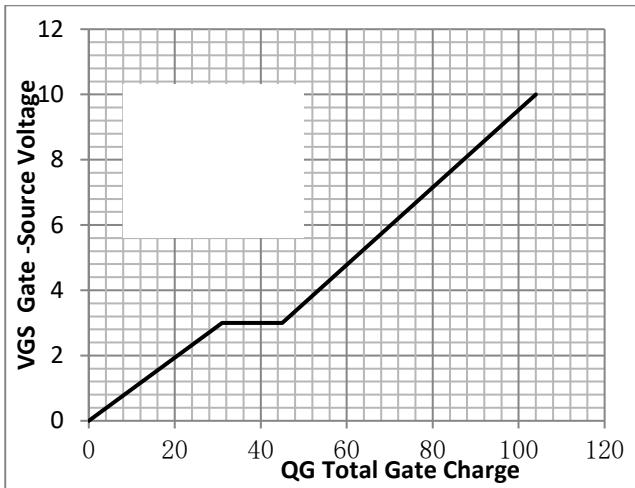


Fig.12 Capacitance Variation

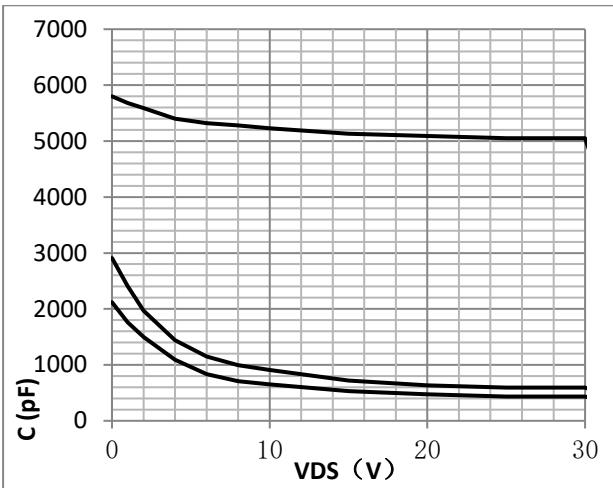


Fig.13 Switching Time Measurement Circuit

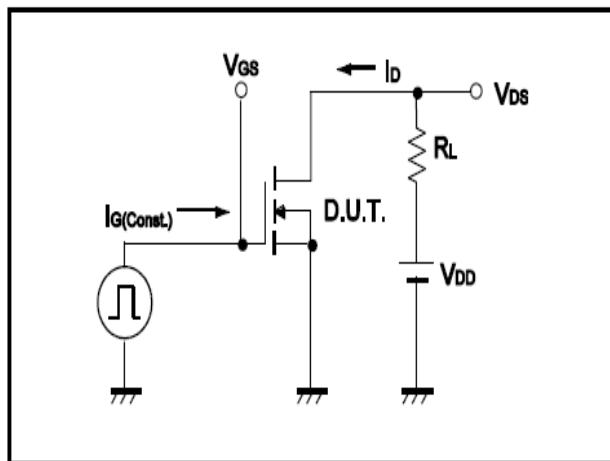


Fig.14 Gate Charge Waveform

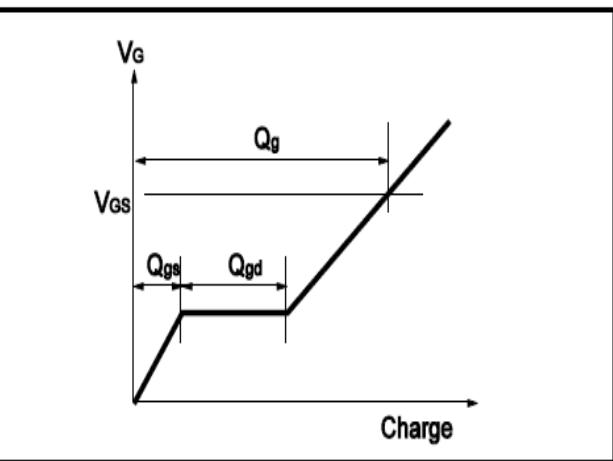


Fig.15 Switching Time Measurement Circuit

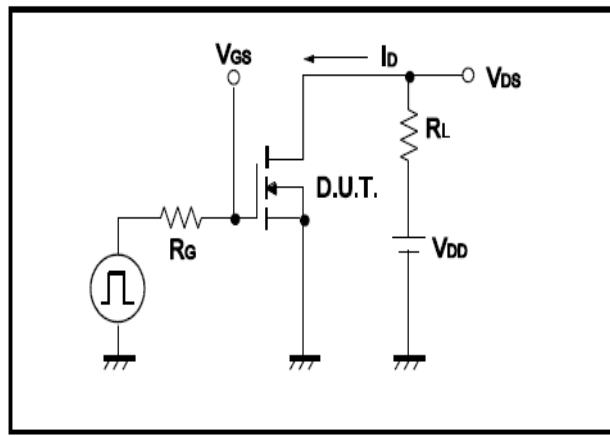


Fig.16 Gate Charge Waveform

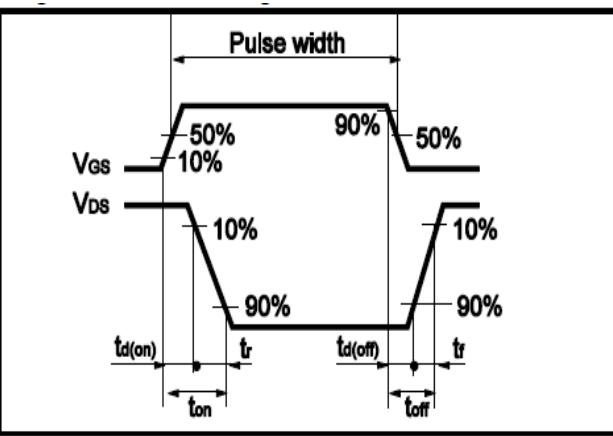




Fig.17 Avalanche Measurement Circuit

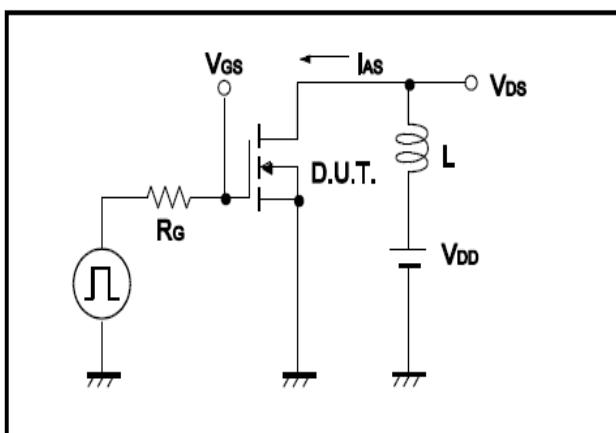
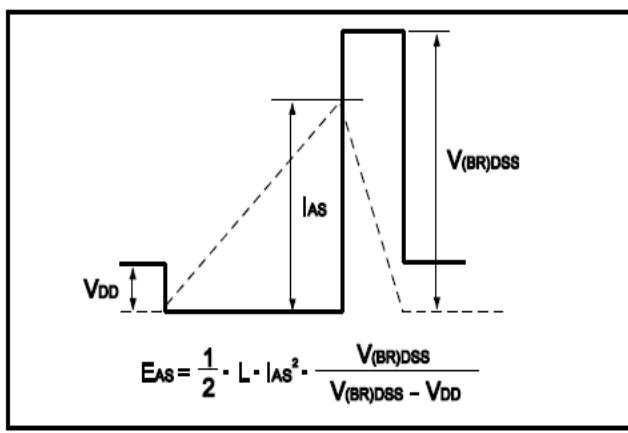


Fig.18 Avalanche Waveform



**•Dimensions(SOP8)**

Unit: mm

SYMBOL	min	TYP	max	SYMBOL	min		max
A	4.80		5.00	C	1.30		1.50
A1	0.37		0.47	C1	0.55		0.75
A2		1.27		C2	0.55		0.65
A3		0.41		C3	0.05		0.20
B	5.80		6.20	C4	0.19	0.20	0.23
B1	3.80		4.00	D		1.05	
B2		5.00		D1	0.40		0.62

